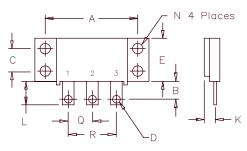
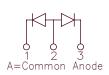
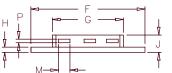
# Schottky Powermod FST16035 — FST16050











Notes:

Baseplate: Nickel plated copper;

electrically isolated Pins: Nickel plated copper

Microsemi	Working Peak	Repetitive Peak
Catalog Number	Reverse Voltage	Reverse Voltage
FST16035*	35V	35V
FST16040*	40V	40V
FST16045*	45V	45V
FST16050*	50V	50V

\*Add the Suffix A for Common Anode, D for Doubler

Dim.	Inches	Millimeters		
Min.	Max.	Min.	Max.	Notes
A 1.995	2.005	50.67	50.93	
B 0.300	0.325	7.62	8.26	
C 0.495	0.505	12.57	12.83	
D 0.182	0.192	4.62	4.88	Dia.
E 0.990	1.010	25.15	25.65	
F 2.390	2.410	60.71	61.21	
G 1.500	1.525	38.10	38.70	
H 0.120	0.130	3.05	3.30	
J	0.400		10.16	
K 0.240	0.260	6.10	6.60 to	Lead G
L 0.490	0.510	12.45	12.95	
М 0.330	0.350	8.38	6.90	
N 0.175	0.195	4.45	4.95	Dia.
P 0.035	0.045	0.89	1.14	
Q 0.445	0.455	11.30	11.56	
R 0.890	0.910	22.61	23.11	

### TO - 249

- Schottky Barrier Rectifier
- Guard Ring for Reverse Protection
- VRRM 35 to 50 Volts
- High Surge Capacity
- Reverse Energy Tested
- ROHS Compliant

#### Electrical Characteristics

F(AV) 160 Amps Average forward current per pkg F(AV) 80 Amps Average forward current per leg İFSM 1200 Amps Maximum surge current per leg Max repetitive peak reverse current per leg R(OV) 2 Amps VFM .58 Volts Max peak forward voltage per leg VFМ .74 Volts Max peak forward voltage per leg RM 30 mA Max peak reverse current per leg Max peak reverse current per leg ŖМ 2 mA

 $^{T}$ C = 115°C, Square wave, R $_{\Theta}$ JC = 0.5°C/W  $^{T}$ C = 115°C, Square wave, R $_{\Theta}$ JC = 1.0°C/W 8.3 ms, half sine  $^{T}$ J = 175°C f = 1 KHz, 25°C, 1 $_{\mu}$ sec Square wave  $^{T}$ FM = 80A:  $^{T}$ J = 175°C\*

| FM = 80A: T J = 25°C\* | VRRM, T J = 125°C\* | VRRM, T J = 25°C | VR = 5.0V, T J = 25°C

\*Pulse test: Pulse width 300µsec, Duty cycle 2%

#### Thermal and Mechanical Characteristics

2300 pF

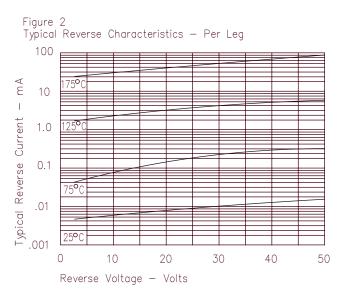
TSTG -55°C to 175°C -55°C to 175°C Storage temp range ТJ Operating junction temp range Maximum thermal resistance per leg  $\mathsf{R} \ominus \mathsf{JC}$ 1.0°C/W Junction to case  $\mathsf{R} \; \ominus \mathsf{JC}$ 0.5°C/W Junction to case Maximum thermal resistance per pkg. Recs 0.1°C/W Typical thermal resistance (greased) Case to sink 15 - 20 inch pounds Mounting torque Weight 2.5 ounces (71 grams) typical

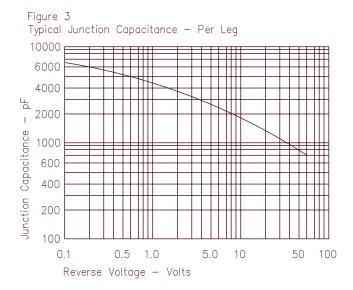


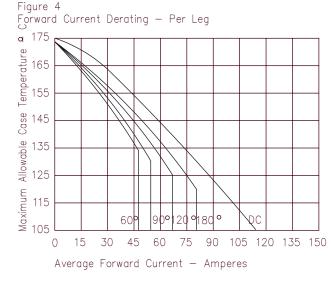
Typical junction capacitance per leg

## FST16035 - FST16050

Figure 1 Typical Forward Characteristics - Per Leg 800 600 400 200 100 80 60 40 Instantaneous Forward Current — Amperes 20 10 8.0 6.0 4.0 2.0 1.0 .2 0 .4 .6 .8 1.0 1.2 1.4 Instantaneous Forward Voltage - Volts











#### **DISCLAIMER**

The information contained in the document (unless it is publicly available on the Web without access restrictions) is PROPRIETARY AND CONFIDENTIAL information of Microsemi and cannot be copied, published, uploaded, posted, transmitted, distributed or disclosed or used without the express duly signed written consent of Microsemi. If the recipient of this document has entered into a disclosure agreement with Microsemi, then the terms of such Agreement will also apply. This document and the information contained herein may not be modified, by any person other than authorized personnel of Microsemi. No license under any patent, copyright, trade secret or other intellectual property right is granted to or conferred upon you by disclosure or delivery of the information, either expressly, by implication, inducement, estoppels or otherwise. Any license under such intellectual property rights must be approved by Microsemi in writing signed by an officer of Microsemi.

Microsemi reserves the right to change the configuration, functionality and performance of its products at anytime without any notice. This product has been subject to limited testing and should not be used in conjunction with life-support or other mission-critical equipment or applications. Microsemi assumes no liability whatsoever, and Microsemi disclaims any express or implied warranty, relating to sale and/or use of Microsemi products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right. Any performance specifications believed to be reliable but are not verified and customer or user must conduct and complete all performance and other testing of this product as well as any user or customers final application. User or customer shall not rely on any data and performance specifications or parameters provided by Microsemi. It is the customer's and user's responsibility to independently determine suitability of any Microsemi product and to test and verify the same. The information contained herein is provided "AS IS, WHERE IS" and with all faults, and the entire risk associated with such information is entirely with the User. Microsemi specifically disclaims any liability of any kind including for consequential, incidental and punitive damages as well as lost profit. The product is subject to other terms and conditions which can be located on the web at http://www.microsemi.com/legal/tnc.asp

#### Life Support Application

Seller's Products are not designed, intended, or authorized for use as components in systems intended for space, aviation, surgical implant into the body, in other applications intended to support or sustain life, or for any other application in which the failure of the Seller's Product could create a situation where personal injury, death or property damage or loss may occur (collectively "Life Support Applications").

Buyer agrees not to use Products in any Life Support Applications and to the extent it does it shall conduct extensive testing of the Product in such applications and further agrees to indemnify and hold Seller, and its officers, employees, subsidiaries, affiliates, agents, sales representatives and distributors harmless against all claims, costs, damages and expenses, and attorneys' fees and costs arising, directly or directly, out of any claims of personal injury, death, damage or otherwise associated with the use of the goods in Life Support Applications, even if such claim includes allegations that Seller was negligent regarding the design or manufacture of the goods.

Buyer must notify Seller in writing before using Seller's Products in Life Support Applications. Seller will study with Buyer alternative solutions to meet Buyer application specification based on Sellers sales conditions applicable for the new proposed specific part.

